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ATION FORM COVER SHEET

U.S. Department of Cd Patent and Trademarico

| | PATENTS ONLY | 055 |
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| | To the Honorable Assistant Commissioner for original documents or | |
| 1. | Name of conveying party(ies): Yu-Chang Chow; W. H. Cheng; Chia-Fu Yeh; C. M. Chi; Cobby Lee | Name/address of receiving Party(ies): United Silicon Incorporated No. 3, Li-Hsin II Rd., Science-Based |
| | Nature of conveyance: ☐ Assignment ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment Date(s) of execution: March 5, 1999; March 9, 1999; March 12, 1999 | Industrial Park, Hsinchu, Taiwan, R.O.C. Add'1 names of receiving parties Attached? Yes No |
| 5. | Application number(s) or patent number(s): If this documents is being filed tog execution date of the application is 12, 1999 | gether with a new application, the |
| | A. Patent Application No. (s) | B. Patent No. (s) 09/286008 |
| | Additional numbers attached | ? □ Yes ☒ No |
| 6. | Name and address of party to whom correspondence concerning document should be mailed: J.C. Patents, Inc. 1340 Reynolds Ave., Suite 114 Irvine, CA 92614 (949) 660-0761 | 7. Total No. of applications and patents involved: ONE(1) 8. Total fee (37 CFR §3.41): \$40.00 Enclosed Charge to Acct. No. 9. Total number of pages, including cover sheet, attachments and document 3. |
| | DO NOT USE TH | HIS SPACE |
| | Statement and Signature: To the best of my Knowledge and believe and correct and any attached copy is a transfer of Person Signing Signature: | ue copy of the original document. |
| | Name of Person Signing Signatu | re / Date |

Registration No. 43, 330

04/26/1999 TTOH11 00000015 09286Q08 01 FC:581

ASSIGNMENT

WHEREAS.

1. Yu-Chang Chow

2. W. H. Cheng

3. Chia-Fu Yeh

4. C. M. Chi

5. Cobby Lee

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR CLEANING INTERIOR OF ETCHING CHAMBER

| [] Filed: | Serial No. |
|------------|------------|
| I I FIECT | Serial No |
| | |

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Silicon Incorporated

of No. 3, Li-Hsin II Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s)

| indicated. | |
|--|-------------------|
| Signature: Sole or First Joint Inventor: Yu-Chang Chow | 3/5/99 Date: |
| Signature: Second Joint Inventor (if any): W. H. Cheng | ラ/12/199 Date: |
| Signature: Third Joint Inventor (if any): Chia-Fu Yeh | 3/9/49 Date: |
| Signature: Fourth Joint Inventor (if any): C. M. Chi | 3/9/99 Date: |
| Signature: | 2/f 8 f |

Signature:

Fifth Joint Inventor (if any): Cobby Lee

RECORDED: 04/05/1999